

Geneva, Switzerland - January 2018

Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Fri	Credit
Abbott, John	Corning Incorporated	Corning Incorporated	1	1	1	1		4
Abedy, Yossuf		Pulse Electronics	1	1	1	1	1	5
Abramson, David	Texas Instruments Incorporated	Texas Instruments Incorporated		1	1	1		3
Agnes, Andrea	STMicroelectronics	STMicroelectronics	1	1	1	1		4
Akkihal, S	Microchip Technology, Inc.	Microchip Technology, Inc.	1	1	1			3
Amezcuca, Adrian	Prysmian Cables & Systems	Prysmian Group		1				1
Anslow, Peter	Ciena Corporation	Ciena Corporation	1	1	1	1	1	5
Baden, Eric	Broadcom Corporation	Broadcom Corporation				1	1	2
Bains, Amrik	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	1	5
Baldwin, Thananya	Keysight Technologies	Ixia	1	1	1	1	1	5
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1		4
Bergner, Bert	TE Connectivity Germany GmbH	TE Connectivity		1	1	1	1	4
Beruto, Piergiorgio	Canovatech S.r.l.	Canova Tech Srl	1	1	1			3
Bhatt, Vipul	Finisar Corporation	Inphi Corporation	1	1	1	1	1	5
Bo, Gian Marco		Canovatech	1	1				2
Bonk, Rene	Nokia	Nokia			1	1		2
Booth, Brad	Microsoft Corporation	Microsoft Corporation		1		1	1	3
Brandt, David	Rockwell Automation	Rockwell Automation	1	1	1	1		4
Braun, Ralf-Peter	Deutsche Telekom AG	Deutsche Telekom AG	1	1	1	1	1	5
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions	1	1	1			3
Brown, Alan M	ADTRAN Inc.	ADTRAN Inc.		1	1	1	1	4
Brown, Matthew	MACOM	Applied Micro (AMCC)	1	1	1		1	4
Brychta, Michal		Analog Devices Inc.	1	1	1	1		4
Butter, Adrian	GLOBALFOUNDRIES	GLOBALFOUNDRIES	1	1	1	1	1	5
Calvin, John	Vital Technical Marketing, Wilder Tec	VTM, V-Prime, Wilder Technologies	1	1	1	1	1	5
Chabot, Craig	University of New Hampshire InterO	University of New Hampshire InterO	1	1				2
Chadha, Mandeep	Microsemi Corporation	Microsemi Corporation	1	1	1	1		4
Chang, Xin	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd		1	1	1	1	4
Chang, Yongmao	Inphi Corporation	Inphi Corporation		1	1	1	1	4
Chen, Chan	Applied Optoelectronics, Inc.	Applied Optoelectronics, Inc.	1	1	1	1	1	5
Choudhury, Golam	OFS	OFS	1	1	1	1		4

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Dai, Eugene	Cox Communications Inc.	Cox Communications Inc.			1	1		2
D'Ambrosia, John	Futurewei Technologies	Futurewei (Subsidiary of Huawei)	1	1	1	1	1	5
Darshan, Yair	Microsemi Corporation	Microsemi Corporation			1			1
Dawe, Piers J G	Mellanox Technologies	Mellanox Technologies	1	1	1	1	1	5
Dawson, Fred	Chemours Canada Company	Chemours Canada Company			1	1		2
den Besten, Gerrit		NXP Semiconductors	1	1	1	1	1	5
DeSanti, Claudio	Cisco Systems, Inc.	Google		1	1	1	1	4
Diminico, Christopher	M C Communications, LLC	Panduit Corp.		1	1	1	1	4
Donahue, Curtis	University of New Hampshire InterO	UNH-IOL	1	1		1		3
Du, Liang	Google	Google			1	1	1	3
Dudek, Michael	Cavium	Cavium	1	1	1	1	1	5
Effenberger, Frank	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd		1	1	1	1	4
Engbretson, Michael		Granite River Labs		1	1			2
Estes, David	Spirent Communications	Spirent Communications	1	1	1	1	1	5
Ewen, John	GLOBALFOUNDRIES	GLOBALFOUNDRIES	1	1	1	1	1	5
Fathi Moghadam, Borhan	NVIDIA Corporation	NVIDIA Corporation	1	1	1	1	1	5
Flatman, Alan	LAN Technologies Corporation, Inc.	LAN Technologies Corporation, Inc.	1	1	1	1	1	5
Franchuk, Brian	Emerson Automation Solutions	Emerson Automation Solutions	1	1	1	1		4
Fritsche, Matthias	HARTING Technologie Gruppe	HARTING Electronics GmbH	1	1	1	1	1	5
Gauthier, Claude	OmniPhy	OmniPhy	1	1	1			3
Geest, Jan	FCI USA Inc.	FCI USA Inc.				1		1
Geng, Dan	ZTE Corporation	ZTE		1	1	1	1	4
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC, Huawei LTD	1	1	1	1	1	5
Gong, Zhigang	O-Net Communications Ltd.	O-Net Communications Ltd.	1	1	1	1		4
Gorshe, Steven Scott	Microsemi Corporation	Microsemi Corporation		1	1	1	1	4
Gottron, Jens	Siemens AG	Siemens AG	1	1	1	1		4
Graber, Steffen	Pepperl+Fuchs GmbH	Pepperl+Fuchs GmbH	1	1	1	1	1	5
Grau, Olaf	Robert Bosch GmbH	Robert Bosch GmbH		1	1	1		3
Gray, Eric W	Ericsson AB	Ericsson AB				1		1
Grillaert, Joost	Nexans	Nexans	1	1	1	1		4
GUO, YONG	ZTE Corporation	ZTE Corporation		1	1	1	1	4

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Gustlin, Mark	Xilinx Inc	Xilinx	1	1	1	1	1	5
Hajduczenia, Marek	Charter Communications	Charter Communications	1	1	1	1	1	5
Han, Ruibo	China Mobile Communications Corp	China Mobile Communications Corp			1			1
Harstead, Ed	Nokia	Nokia		1	1			2
Harwood, Michael		HSZ Consulting Ltd			1	1	1	3
Hayakawa, Akinori	FUJITSU LABORATORIES LIMITED	FUJITSU LABORATORIES LIMITED	1	1	1	1	1	5
Healey, Adam	Broadcom Ltd.	Broadcom Ltd.	1	1	1	1	1	5
Heck, Howard	Intel Corporation	Intel Corporation	1	1	1	1	1	5
Hegde, Rajmohan	Broadcom Corporation	Broadcom Corporation	1		1		1	3
Hormmeyer, Bernd	Phoenix Contact	Phoenix Contact	1	1	1	1		4
HUANG, Xi	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	1	5
Huszak, Gergely	Self	Kone	1	1	1	1		4
Ingham, Jonathan	Foxconn Interconnect Technology	Foxconn Interconnect Technology	1	1	1	1		4
ingrassia, alessandro	canova tech	canova tech	1	1	1			3
Isono, Hideki	FUJITSU	Fujitsu Optical Components Limited	1	1	1	1	1	5
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co. Ltd	1	1	1	1	1	5
Jackson, Kenneth	Sumitomo Electric Device Innovation	Sumitomo Electric Industries, LTD	1	1	1	1		4
Jimenez, Andrew	Anixter Inc.	Anixter Inc.	1	1	1	1		4
Johnson, John	Broadcom Limited	Broadcom Limited	1		1	1	1	4
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.			1	1		2
Jones, Peter	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Kabra, Lokesh	Synopsys, Inc.	Symopsys, Inc.		1		1	1	3
Kappertz, Jannis		Endress+Hauser	1	1	1	1		4
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1		1	1	4
Kattainen, Ari	KONE Oyj	KONE	1	1				2
Kimber, Eric	Semtech Ltd	Semtech Ltd	1	1	1	1	1	5
King, Jonathan	Finisar Corporation	Finisar Corporation	1	1	1			3
Klempa, Michael	University of New Hampshire InterO	University of New Hampshire InterO	1		1			2
Knittle, Curtis	Cable Television Laboratories Inc. (Ca	Cable Television Laboratories Inc. (Ca		1	1	1	1	4
Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1		4
Kolesar, Paul	CommScope	CommScope, Inc.	1	1	1	1	1	5

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Kondo, Taiji	MegaChips Corporation	MegaChips Corporation	1	1	1	1	1	5
Kramer, Glen	Broadcom Corporation	Broadcom Corporation		1	1		1	3
Krieger, Olaf	Volkswagen AG	Volkswagen AG	1	1	1	1	1	5
Kumada, Taketo	Yazaki Corporation	Yazaki Corporation	1	1	1	1	1	5
Lapak, Jeffrey	University of New Hampshire InterO	University of New Hampshire InterO	1	1	1	1		4
Laubach, Mark	Broadcom Limited	Broadcom Corporation		1	1	1	1	4
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	1	5
Le Cheminant, Greg	Keysight Technologies	Keysight Technologies	1	1	1	1		4
Lee, Han Hyub	ETRI	ETRI		1	1		1	3
Lewis, David	Lumentum Inc.	Lumentum Inc.	1	1	1	1	1	5
Lewis, Jon	Dell EMC	Dell	1	1	1	1	1	5
Li, David	Ligent Photonics, Inc.	Hisense-Ligent				1	1	2
Li, Mike-Peng	Intel Corporation	Intel Corporation	1	1	1	1	1	5
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	1	5
Lingle, Robert	OFS	OFS	1	1	1	1	1	5
liu, dekun	Huawei Technologies Co., Ltd	Huawei Technologies Co. Ltd		1	1	1		3
Liu, Hai-Feng	Intel	Intel Corporation	1	1	1			3
Liu, Karen	Kaiam Corp	Kaiam Corporation	1	1	1	1		4
Lukacs, Miklos	Silicon Laboratories	Silicon Laboratories			1	1		2
Lusted, Kent	Intel Corporation	Intel Corporation	1	1	1	1	1	5
Madgar, Zahy	Valens Semiconductor	Valens Semiconductor				1	1	2
Maguire, Valerie	The Siemon Company	The Siemon Company	1	1		1		3
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	1	5
Mansfield, Scott	Telefon AB LM Ericsson	Ericsson AB	1					1
Marris, Arthur	Cadence Design Systems, Inc.	Cadence Design Systems, Inc.	1	1	1	1	1	5
MASUDA, TAKEO	OITDA	OITDA		1	1	1	1	4
Matheus, Kirsten	BMW Group	BMW Group		1	1	1		3
Matoglu, Erdem	Amphenol Corporation	Amphenol Corporation	1	1	1			3
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1				2
McCarthy, Mick	Analog Devices Inc.	Analog Devices Inc.	1	1	1	1		4
Mcclellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	1	5

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McSorley, Gregory	Amphenol Corporation	Amphenol Corporation		1	1	1		3
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.	1	1	1	1		4
Miller, Martin	Microchip Technology, Inc.	Microchip Technology, Inc.			1	1		2
Nakamoto, Edward	Spirent Communications	Spirent Communications	1	1	1	1	1	5
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.	1			1	1	3
Noll, Kevin	TiBiT Communications	Tibit Communications		1	1	1	1	4
Nordin, Ronald	Panduit Corp.	Panduit Corp.	1	1	1	1		4
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	1	5
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	1	5
Ohni, Josef	MD Elektronik GmbH	MD Elektronik					1	1
Orzelli, Antonio		Canova Tech srl	1	1	1			3
Palkert, Thomas	EIC	Molex-Macom	1	1	1	1	1	5
Pandey, Sujan	NXP Semiconductors	NXP Semiconductors	1	1	1	1		4
Pardo, Carlos	Knowledge Development for POF SL	KDPOF	1	1	1	1		4
Parsons, Earl	CommScope, Inc.	CommScope, Inc.	1	1	1	1	1	5
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation		1	1	1		3
Pepper, Gerald	Keysight Technologies	Ixia	1	1	1	1	1	5
Pham, Phong	US Conec, Ltd.	US Conec, Ltd.	1	1				2
Pimpinella, Rick	Panduit Corp.	Panduit Corp.	1	1	1			3
Powell, William	Nokia	Nokia		1	1	1	1	4
RAN, ADEE	Intel Corporation	Intel Corporation	1	1	1	1	1	5
Rerein, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd	1	1	1	1	1	5
Roberts, Hal	Calix	Calix		1	1	1	1	4
Roszbach, Martin	Nexans Cabling Solutions	Nexans SA			1	1		2
Rysin, Alexander	Mellanox Technologies	Mellanox Technologies	1	1	1			3
Sakai, Toshiaki	Socionext	socionext	1	1	1	1	1	5
Scantamburlo, Nicola	Canova Tech	Canova Tech	1	1	1			3
Schicketanz, Dieter	CONSULTANT	CONSULTANT; Reutlingen University	1	1	1			3
Schube, Scott	Intel Corporation	Intel Corporation	1		1	1	1	4
Shariff, Masood	CommScope, Inc.	CommScope, Inc.	1	1	1	1	1	5
Shirao, Mizuki	Mitsubishi Electric Corporation	Mitsubishi Electric Corporation		1	1	1		3

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Shulman, Shaul		Intel Corporation		1	1	1		3
Sommers, Scott	Molex Incorporated	Molex Incorporated	1	1	1	1		4
Sparrowhawk, Bryan	Leviton Manufacturing Co.	Leviton Manufacturing Co.	1	1	1	1		4
Sprague, Edward	Infinera Corporation	Infinera Corporation	1	1	1	1	1	5
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	1	5
Stewart, Heath	Analog Devices Inc.	Analog Devices Inc.	1	1	1	1		4
Stone, Robert	Broadcom Corporation	Broadcom Corporation	1	1		1	1	4
Sun, Junqing	Credo Semiconductor	Credo Semiconductor	1	1	1	1	1	5
Sun, Liyang	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	1	5
Suzuki, Ken-Ichi	Nippon Telegraph and Telephone Co	NTT		1	1	1		3
Swanson, Steven	Corning Incorporated	Corning Incorporated	1	1	1	1		4
Szczepanek, Andre	HSZ Consulting Ltd	HSZ Consulting Ltd			1	1	1	3
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	FUJITSU LABORATORIES LIMITED	1	1	1	1	1	5
Tamura, Kohichi	Oclaro Japan Inc.	Oclaro Japan Inc.	1	1	1	1	1	5
Tan, Alexander	Marvell Semiconductor, Inc.	NXP Semiconductors	1					1
TAZEBAY, MEHMET	Broadcom Corporation	Broadcom Corporation				1		1
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT	1	1	1	1	1	5
Tracy, Nathan	TE Connectivity	TE Connectivity	1	1	1	1	1	5
Tremblay, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1		4
Trowbridge, Stephen	Nokia	Nokia	1	1	1	1	1	5
Umeda, Daisuke	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD		1	1	1	1	4
Umnov, Alexander	Corning Incorporated	Corning Incorporated			1	1	1	3
Vernickel, Ricky		LEONI				1	1	2
Vitali, Marco	Sicoya	Sicoya		1	1	1		3
Walker, Dylan	Cisco Systems, Inc.	Cisco Systems, Inc.			1	1		2
Walter, Edward	AT&T	AT&T		1	1	1	1	4
wang, haifei	Huawei Technologies Co. Ltd	Huawei Technologies Co., Ltd	1	1	1	1		4
Wang, Min		Waymo	1	1	1	1	1	5
Wang, Roy	Hewlett Packard Enterprise	Hewlett Packard Enterprise	1	1	1	1	1	5
Wang, Xinyuan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	1	5
Weber, Markus	socionext	Acacia Communications			1	1		2

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Wechsler, Christoph	Audi AG	Audi AG				1	1	2
Wendt, Matthias	Philips Lighting	Philips Lighting	1	1	1	1		4
Wey, Jun Shan	ZTE Corporation	ZTE Corporation		1	1	1	1	4
Wienckowski, Natalie	General Motors Company	General Motors Company			1	1	1	3
Winkel, Ludwig	Siemens AG	Siemens AG	1	1				2
Withey, James	Fluke Corporation	Fluke Corporation	1	1	1	1	1	5
Wucher, Markus	Endress + Hauser Flowtec AG	Endress + Hauser	1	1	1	1		4
Xu, Dayin	Rockwell Automation	Rockwell Automation	1	1	1	1		4
XU, LI		HUAWEI	1	1	1	1	1	5
Xu, Yu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	1	5
Yamamoto, Shuto	Nippon Telegraph and Telephone Co	Nippon Telegraph and Telephone Co	1	1	1	1	1	5
Young, James	CommScope, Inc.	CommScope	1		1	1		3
Yseboodt, Lennart	Philips Lighting	Philips Electronics	1	1	1	1		4
Zerna, Conrad	Fraunhofer IIS	Fraunhofer IIS	1	1	1	1	1	5
ZHANG, YUN		Huawei Technologies Co., Ltd	1	1	1	1	1	5
Zhong, Qiwen	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd	1	1	1	1	1	5
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	1	5
Zielinski, Martin	Emerson Electric Co.	Emerson Process Management	1	1	1			3
Zimmerman, George	CME Consulting	ADI, APL Group, Aquantia, BMW, Co	1	1		1	1	4
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.	1	1	1	1	1	5
Zou, Gaoling	Maxim Integrated Products	Maxim Integrated Products			1			1
Zweck, Harald	Infineon Technologies AG	Infineon Technologies AG	1	1	1			3